

[54] WAFER HOLDING FRAME

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[52] U.S. Cl. .... D9/367

[58] Field of Search ..... 211/41; 219/121 PG; 156/345, 627, 643; 414/417, 222, 416, 404, 217; D14/99; 206/334, 454; D13/40, 41; D9/367, 341, 455, 456, 499, 418

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[57] CLAIM

The ornamental design for a wafer holding frame, as shown.

DESCRIPTION

FIG. 1 is a front elevational view of a wafer holding frame showing our new design; FIG. 2 is a rear elevational view thereof; FIG. 3 is a top plan view thereof; FIG. 4 is a bottom plan view thereof; FIG. 5 is a right side elevational view thereof; and FIG. 6 is a cross sectional view thereof taken along line A—A in FIG. 1.

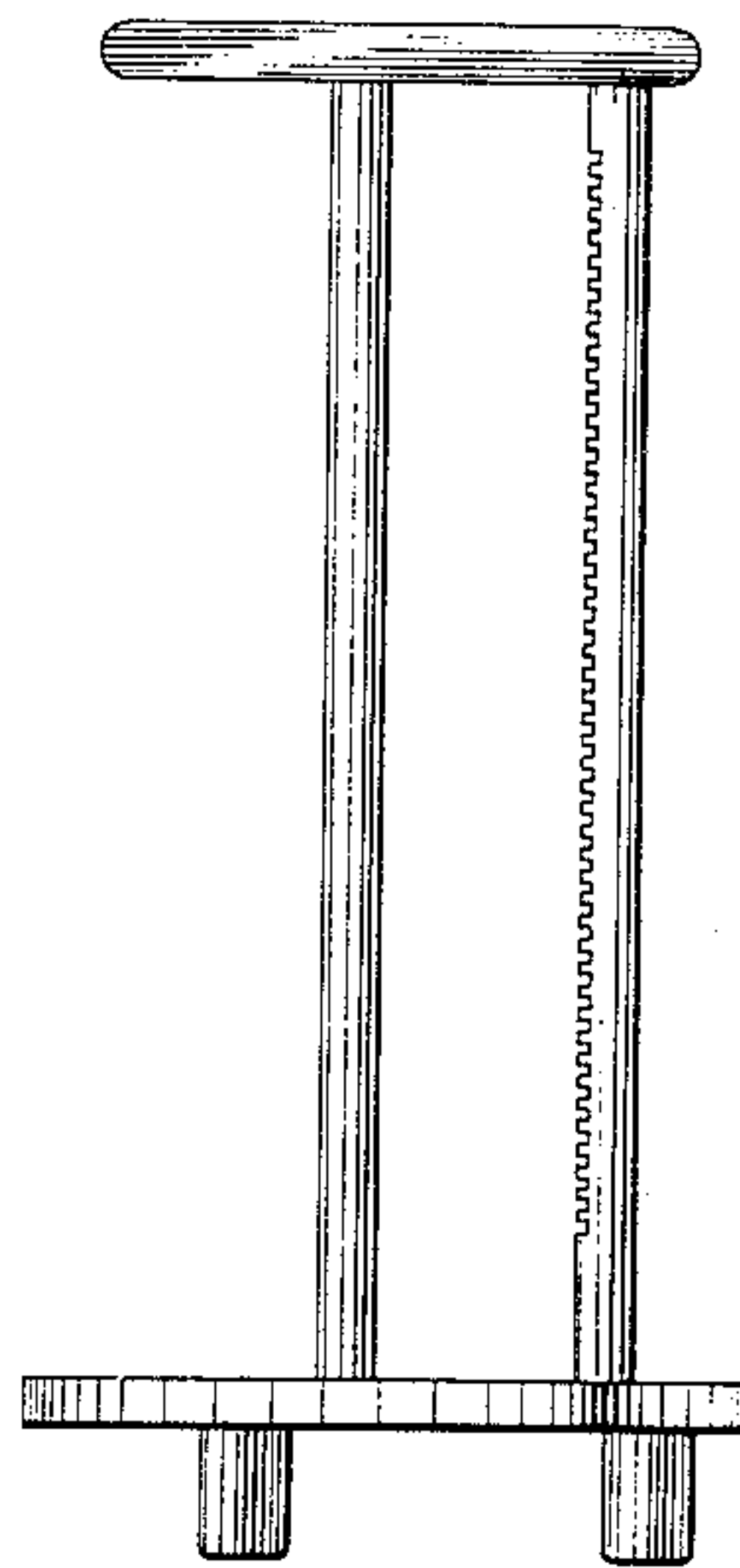


FIG.1

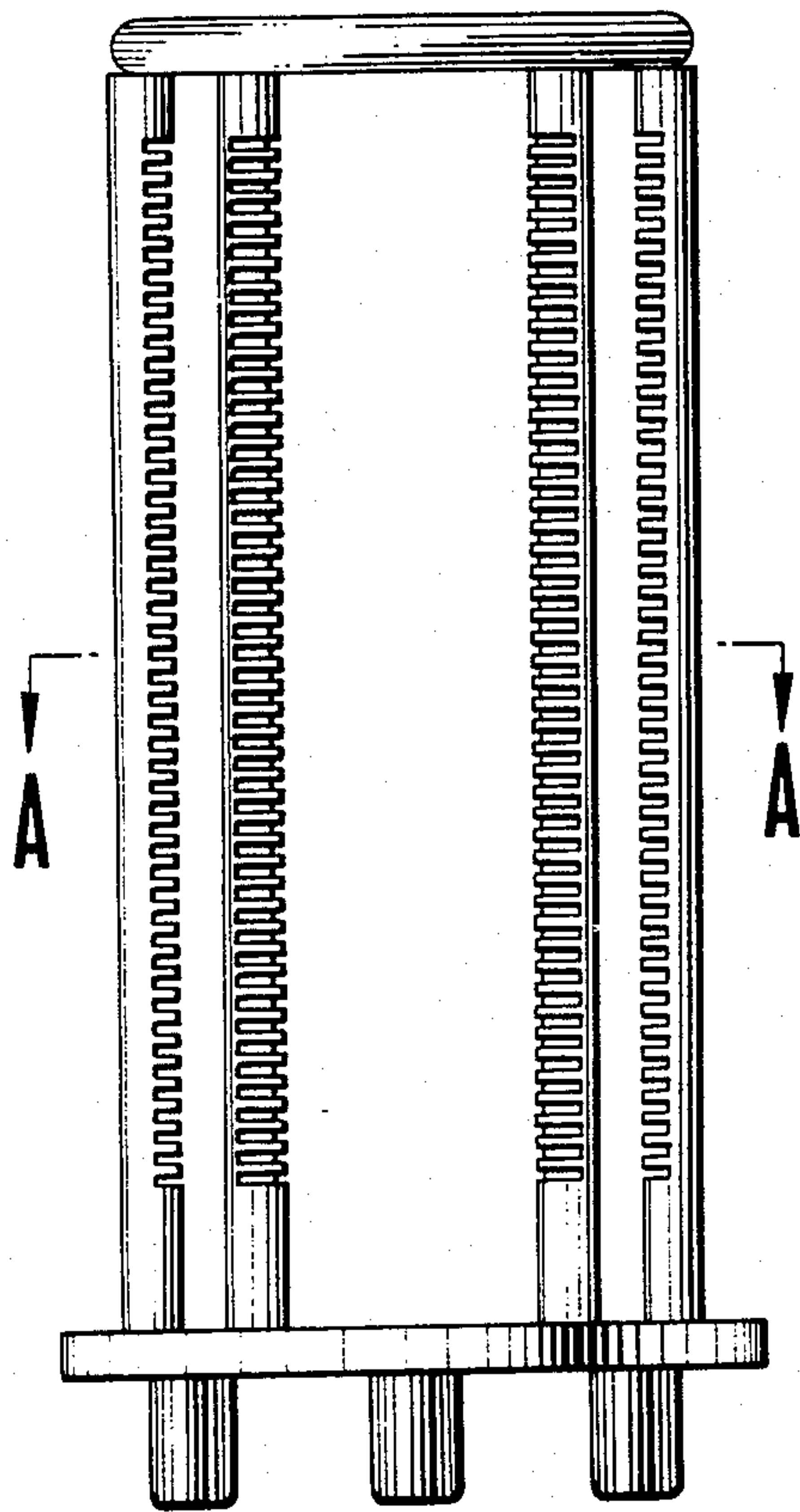


FIG.2

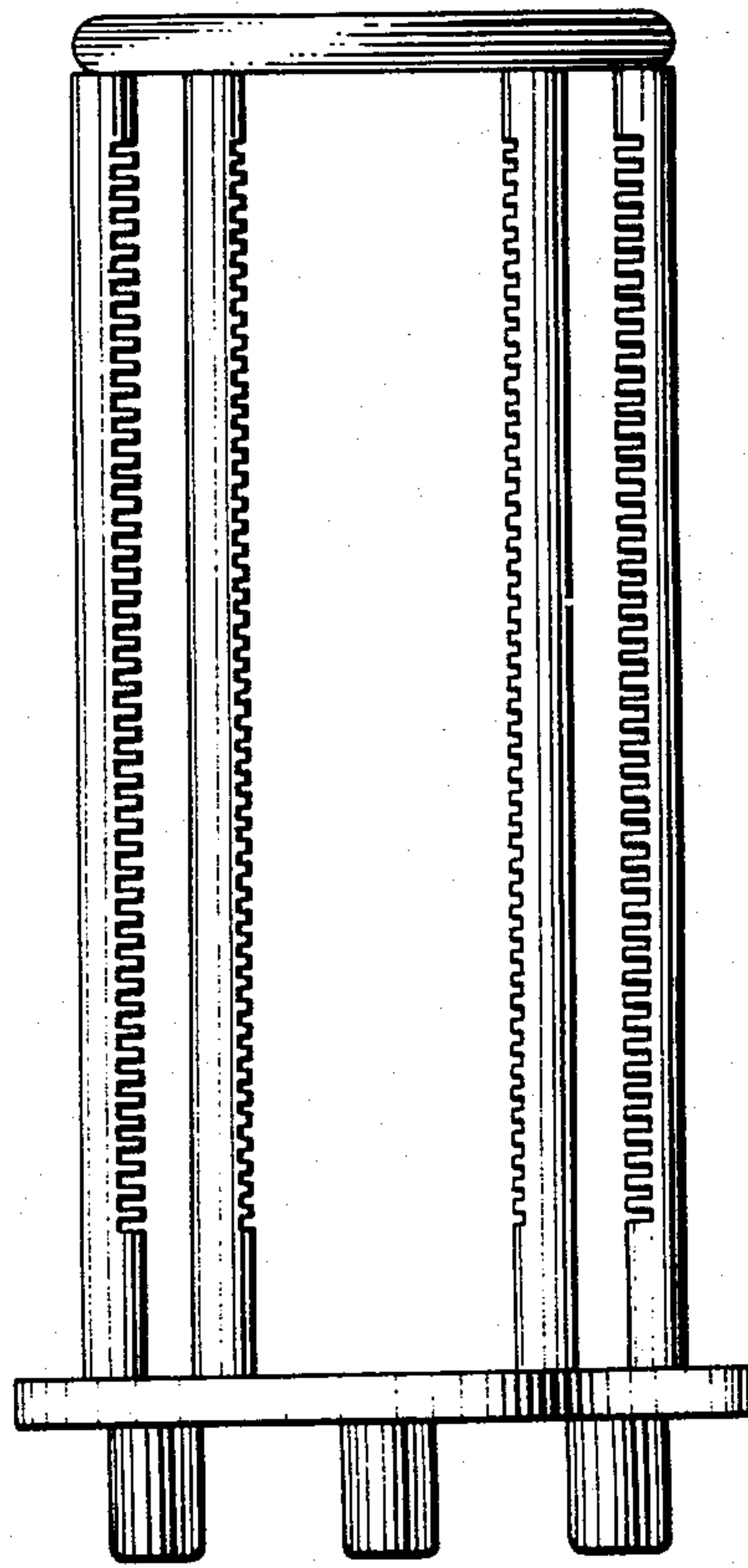


FIG.3

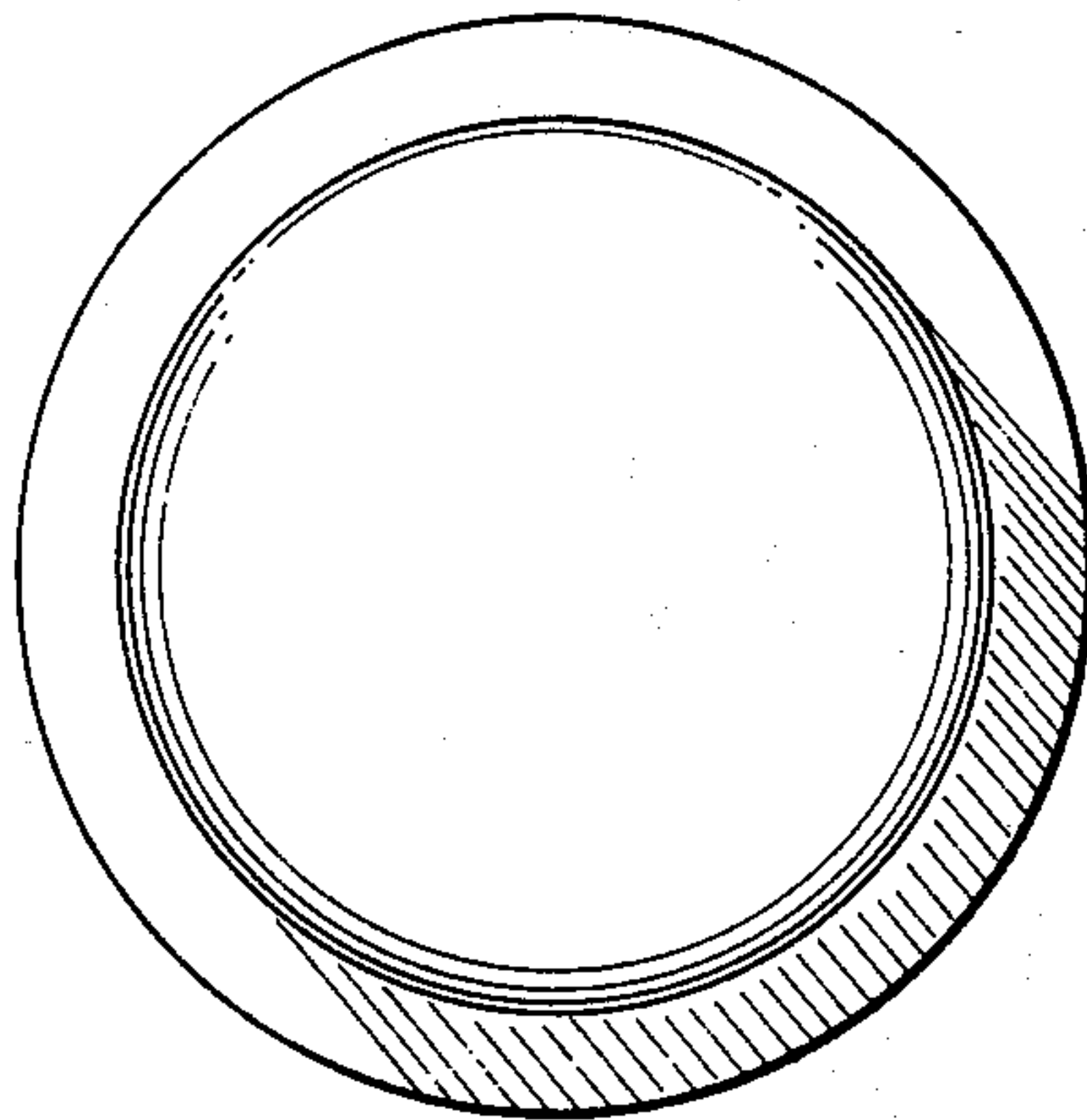


FIG.4

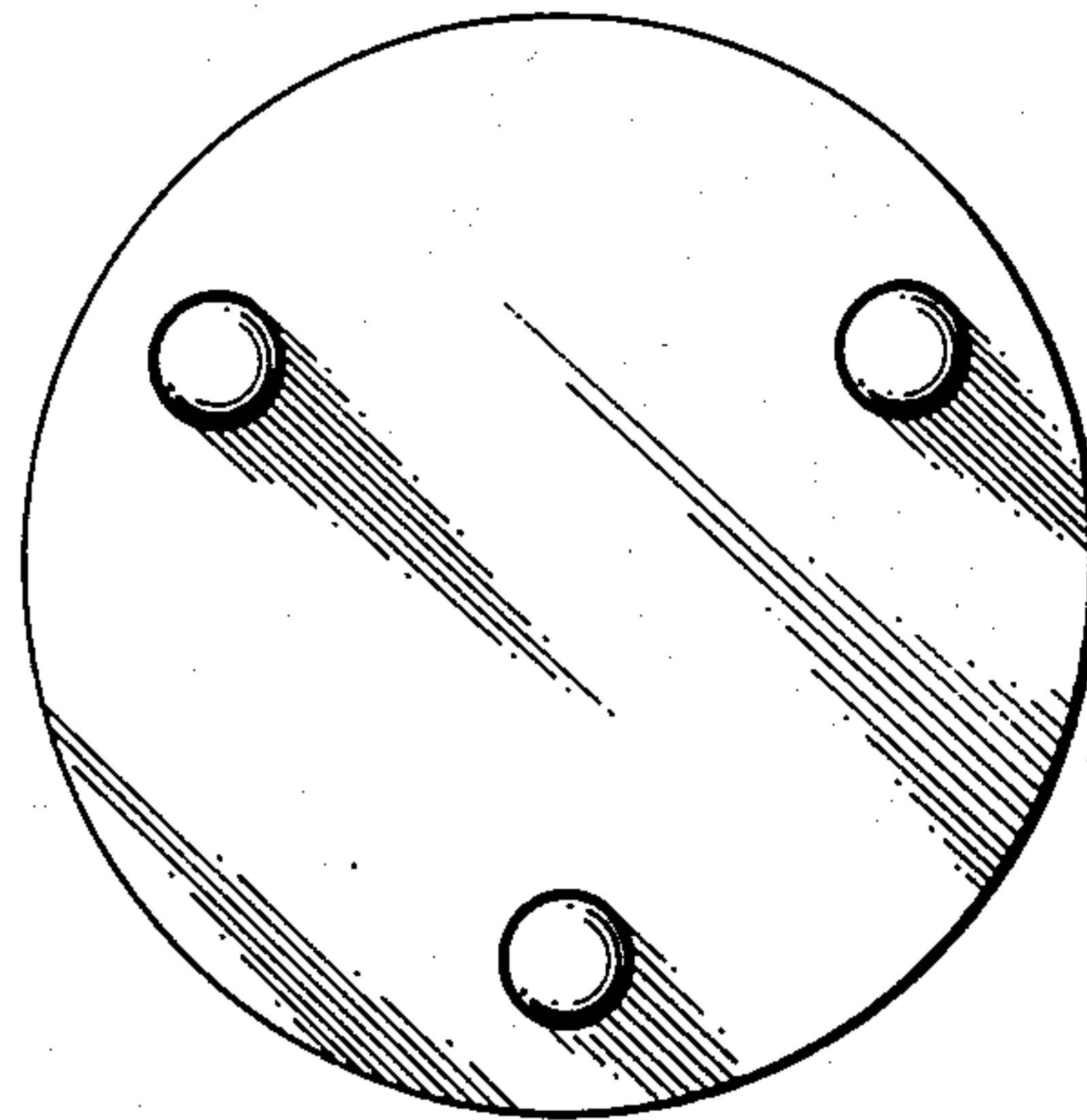


FIG. 5

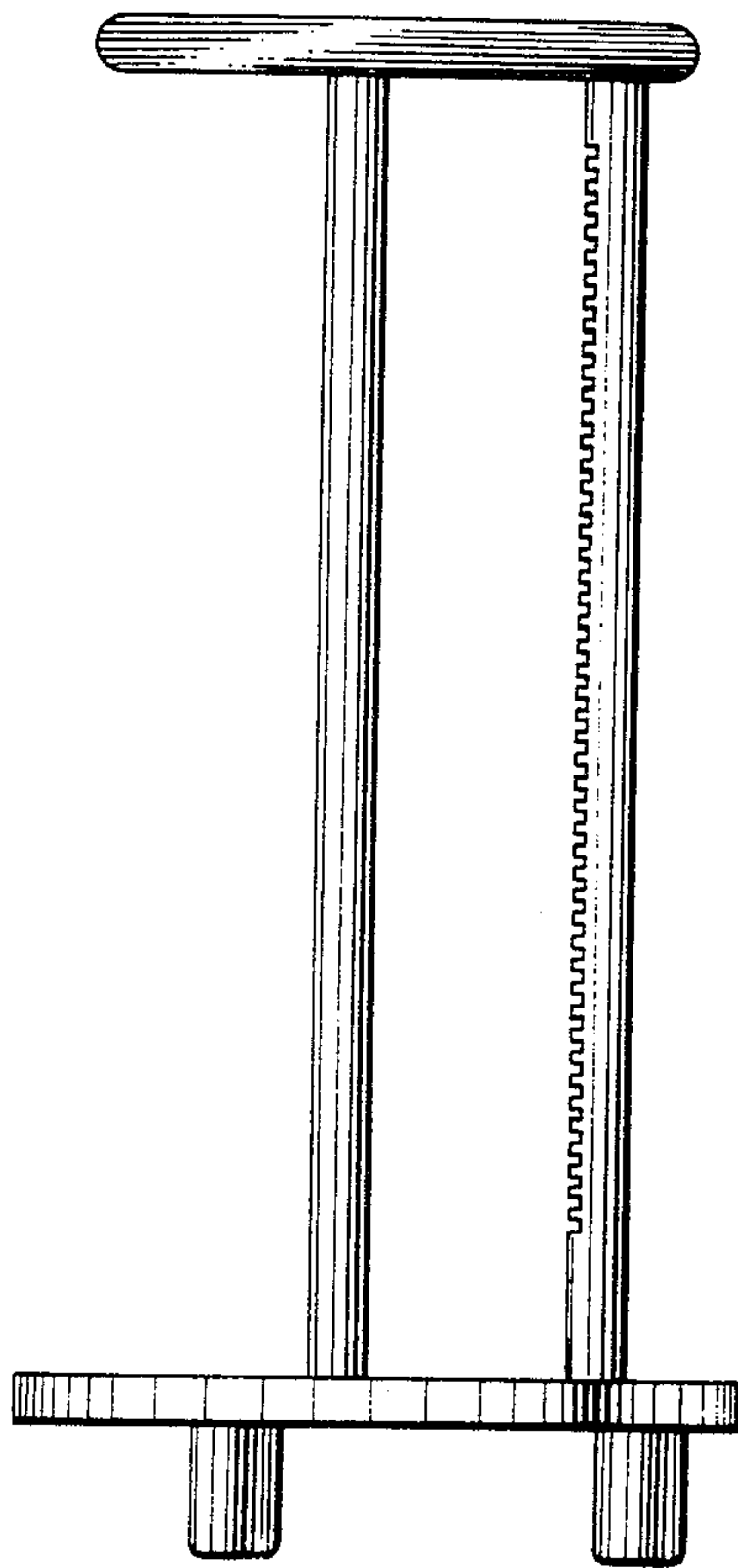


FIG. 6

